



Degradation of Thermal Conductivity of Epoxy Resin- Diamond Filler Composites Under Radiation

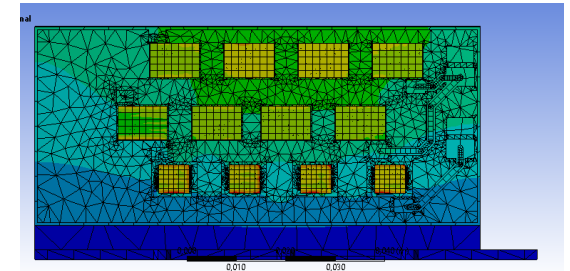
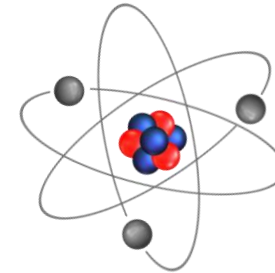
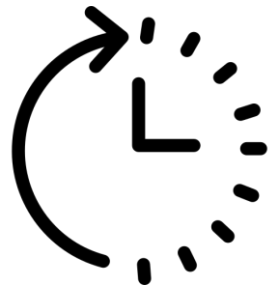
Presenter: Tuyana Ligdenova

What are radiation-resistant thermal adhesive?

Designed for high-radiation environments (e.g., nuclear power plants, space technology, readout electronics).

Key requirements for the electronics of the accelerator:

- High thermal conductivity (Crucial for efficient heat removal in electronics)
- High electrical resistance
- Durability (Most of the analogs are pastes that cannot be used for several years)
- Radiation-resistant (Cracks in the adhesive during radiation)



or



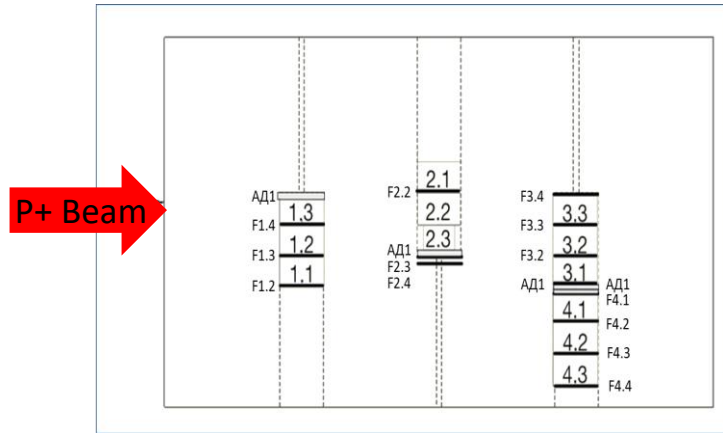
Comparison of resins for thermal glue

Adhesives	Thermal Cond. (W/m.K)	Oper. Temp. (°C)	Viscosity (Pa.s)	Elec. Resistivity (Om.cm)	Curing	Rad. Hard, Mrad	shear strengt h (MPa)
HT2	N/A	N/A	0,330±100 low Viscosity	N/A	24 h 23°C+ 10h 50°C	N/A	N/A
ED-20	0,3-0,6	55-170	13-20 middle Viscosity	10 ¹⁴	20 h 25°C	200-300	>25

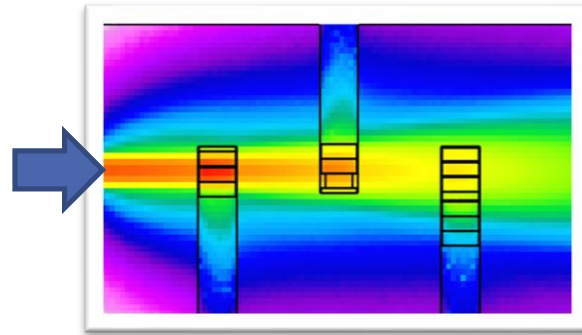
Filler used

Filler	Thermal conductivity	Dialectical strength
<i>C (diamond)</i>	900 - 2000 W/(m·K)	20×10⁶ V/mm

Experimental methodology



Irradiation of samples



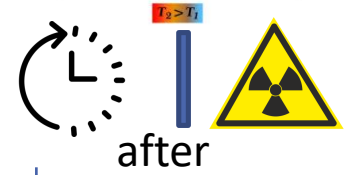
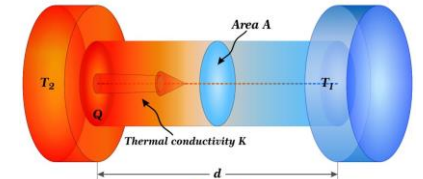
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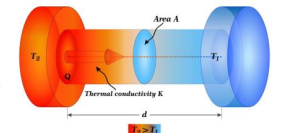
Analysis

- Modeling using FLUKA and MNCPIX
- Calculation of absorbed dose

Thermal conductivity λ
before

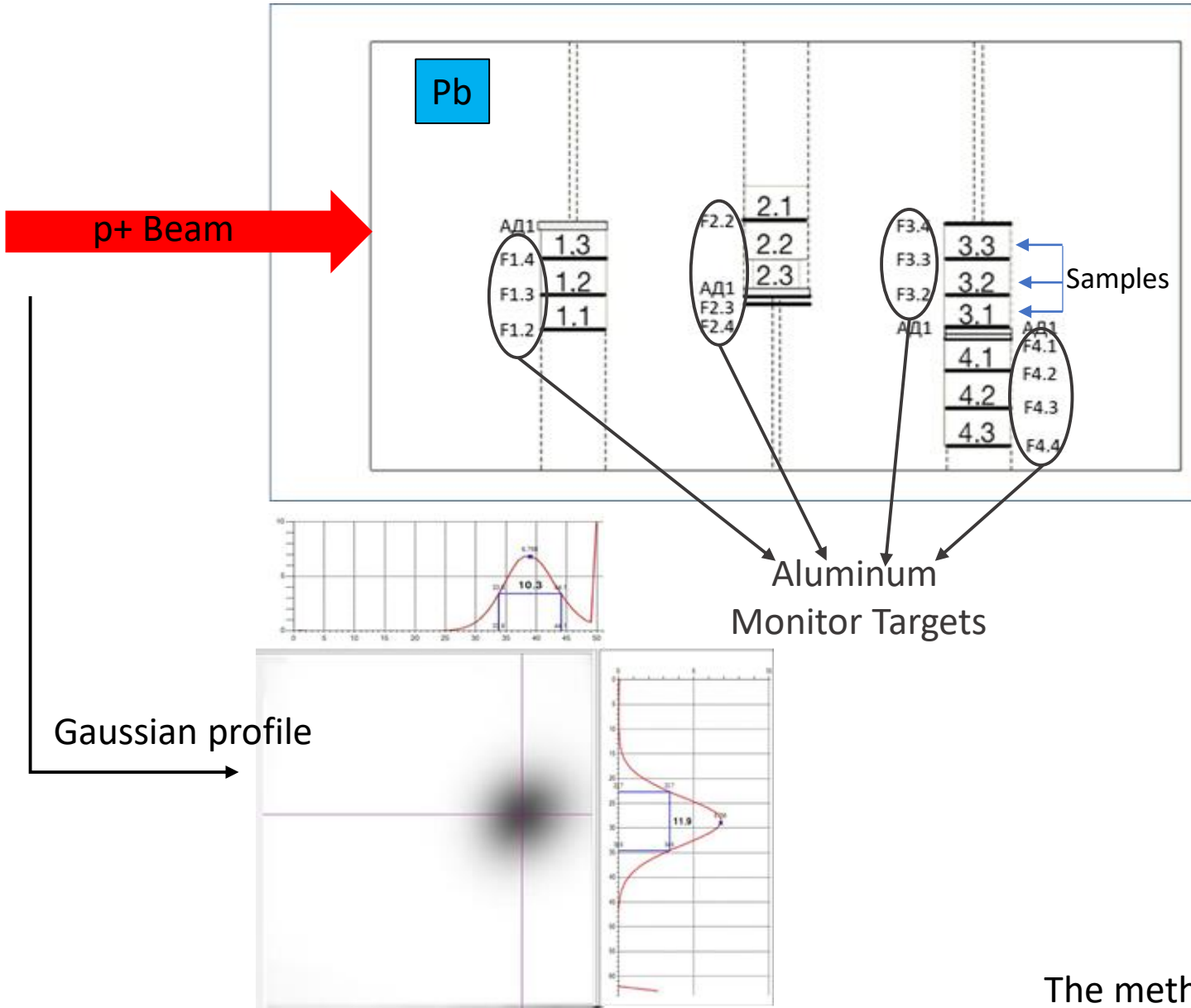


λ
How much?



Comparison of thermal conductivity values before and after irradiation

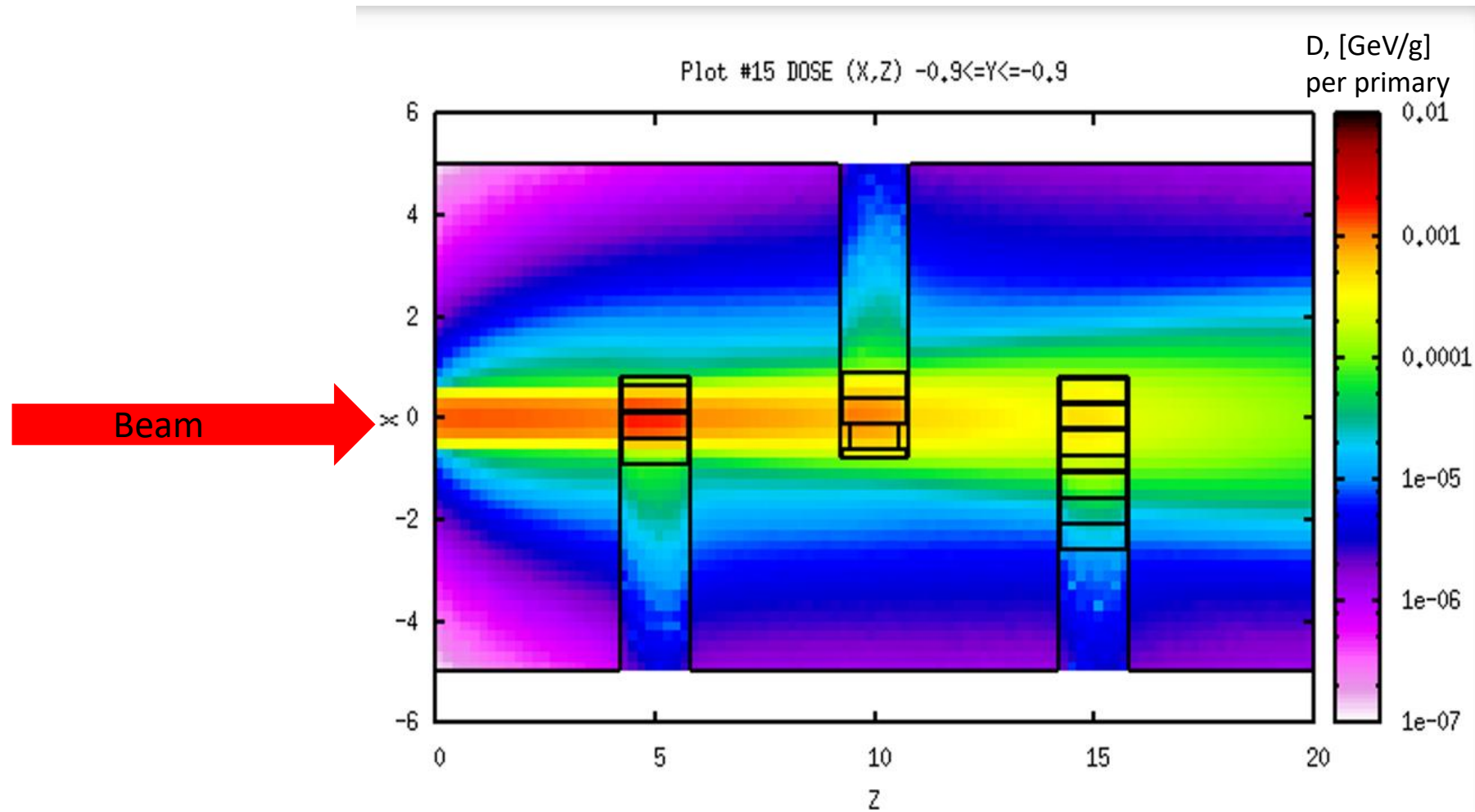
Experimental setup



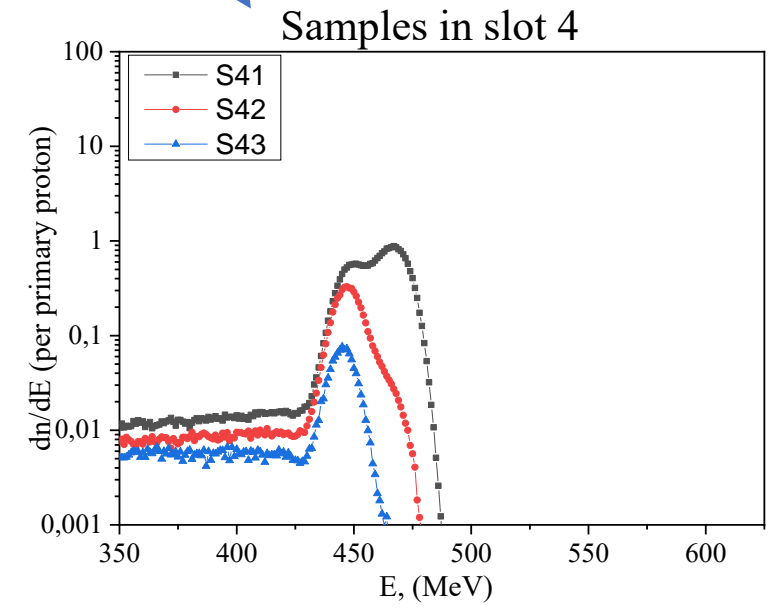
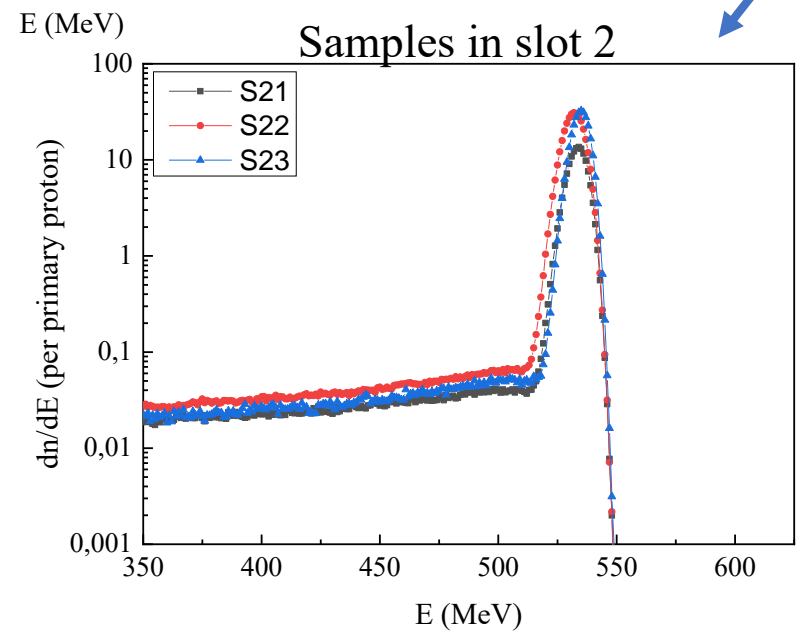
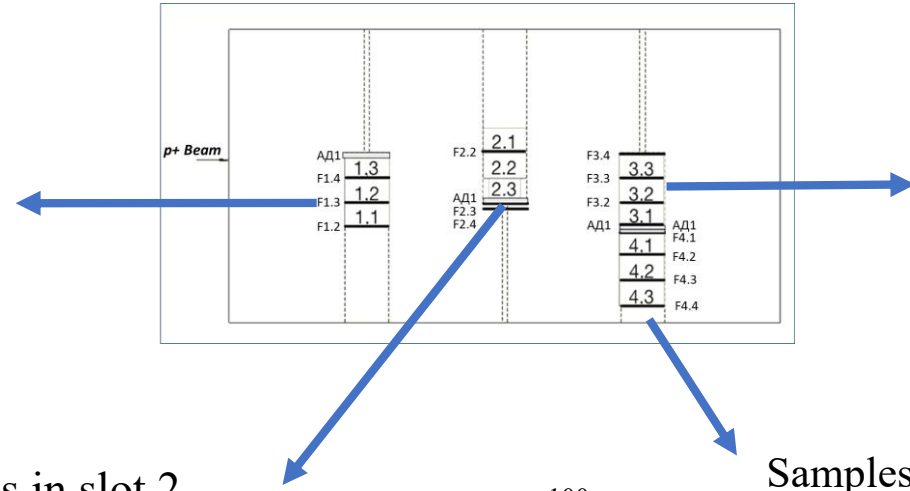
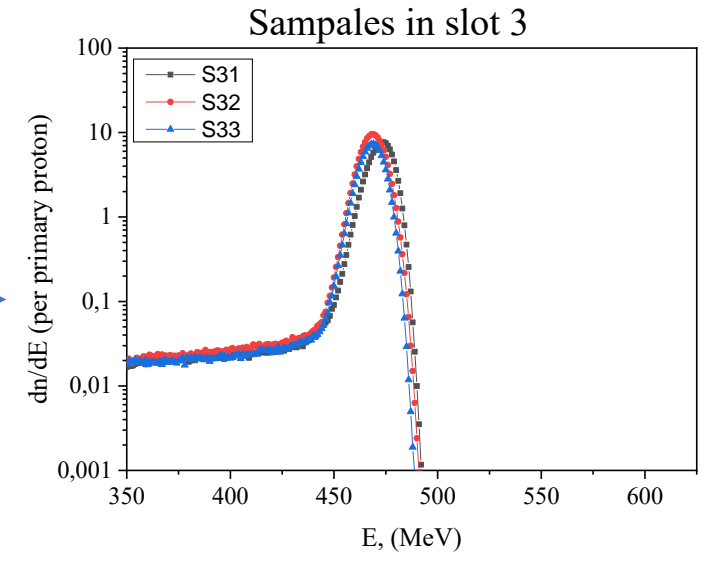
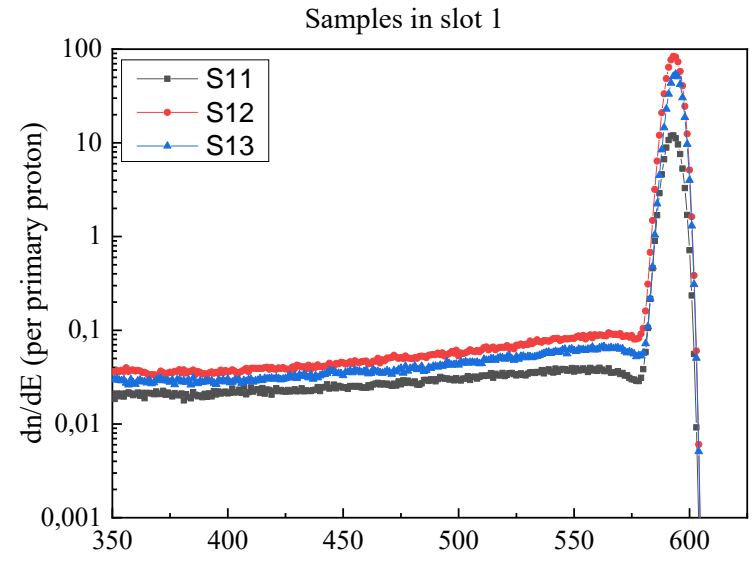
Sample sizes : \varnothing 15 mm, d = 5 mm.
 Aluminum targets: \varnothing 15 mm,
 d = 80 microns.

The lead target was irradiated with a proton beam from the JINR DLNP phasotron
 Beam diameter – **10 mm**
 Energy of protons in a beam - **660 MeV**
I = 1 μ A
 Irradiation time -**15 min**

Spatial distributions of absorbed doses in the assembly



Energy spectra of protons at slots



Determination of particle fluence at the irradiation time

The initial activity (A_0) of the aluminum monitor ($t=0$) was calculated from activity measured after 10 months as:

$$N_0 = A_0 / \lambda \quad \rightarrow \quad A_0 = \frac{S/\tau}{\gamma(^{22}\text{Na}) * e^{-\lambda t} * \epsilon}$$

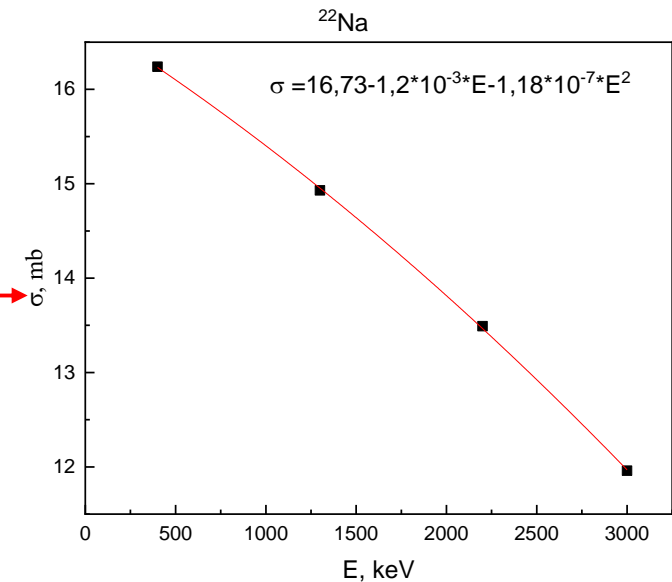
by simple transformations (believe me)

Fluence

$$F = \frac{N * M}{\sigma * \rho * d * N_A * S}$$

- N - number of ^{22}Na nuclei,
- M - molar mass of aluminum,
- σ - cross section through ^{22}Na ,
- ρ - aluminum density,
- d - thickness of the aluminum target,
- N_A - Avogadro's number,
- S - Al monitor foil area.

Nuclide	Half-life time	Main γ -rays energies (keV)	Absolute intensity(%)
^7Be	53 days	477.6	10.44
^{22}Na	2.6 years	1274.5	99.9
^{24}Na	15 hours	1368.6 2745	99.99 99.86



Graph of the dependence of the activation cross-section on the particle energy for the element ^{22}Na

*H. Matsuda. Iwamoto "Proton-induced activation cross section measurement for aluminum with proton energy range from 0.4 to 3 GeV at J-PARC ", 23 March 2018.

Determination of absorbed dose

To calculate the irradiation dose of the samples, only **proton** interaction was taken into account.

The **stopping power (s)** elements included in the adhesives have been assessed:

$$s * \frac{1}{\rho} = \sum_i \omega_i * \left(\frac{dE}{dx} \right)_i$$

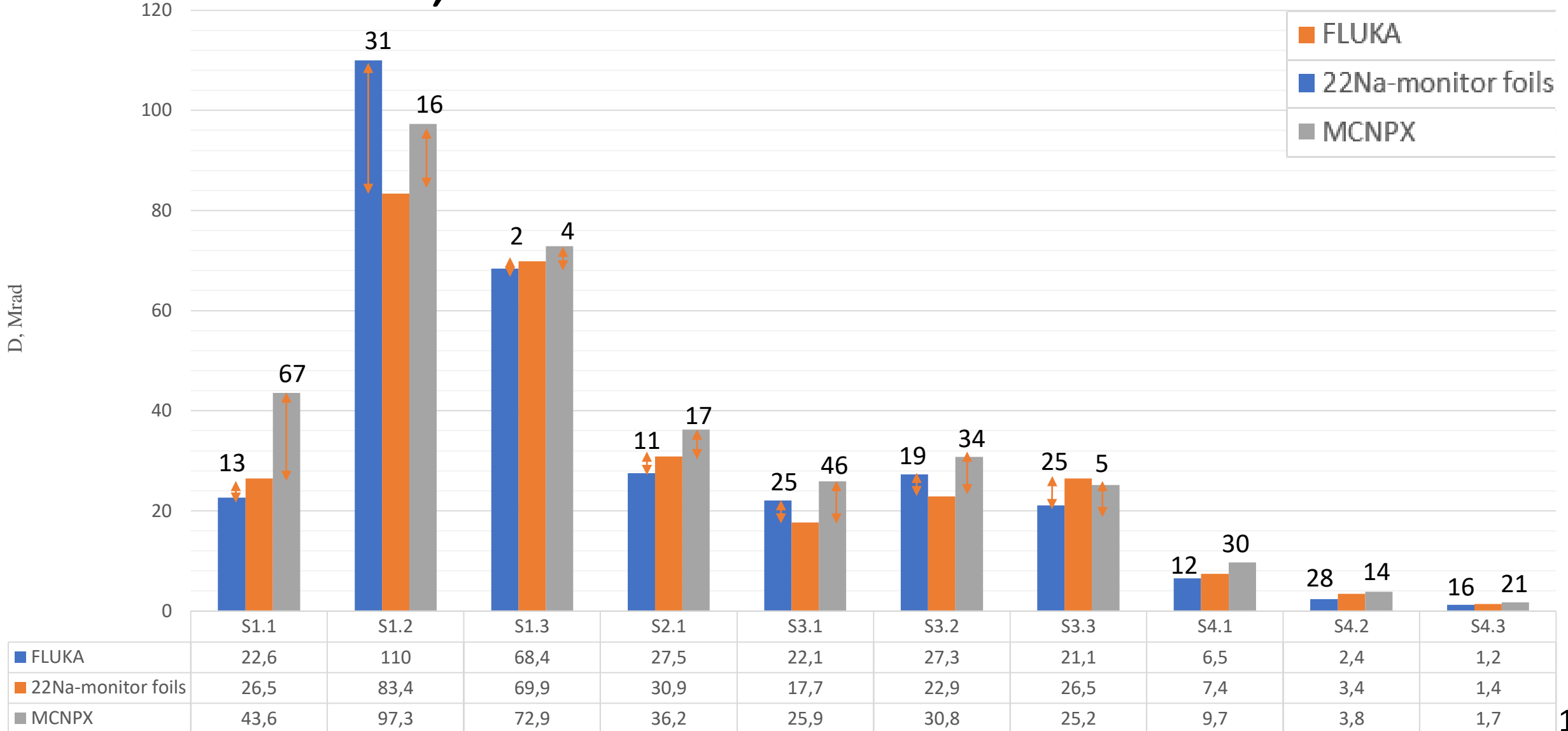
The **mean free path (R)** for each sample was calculated using the FLUKA program, and since $d \ll R$ is true for our samples, we can find the energy loss after passing through a material of thickness d using the formula:

$$E = \left(\frac{dE}{dx} \right)_0 * d$$

The total energy is defined as the product of the energy (E_{total}) and the number of particles per unit area of the target, located perpendicular to the beam axis ($dN = F \cdot S$). From here we can express the radiation dose D :

$$D = \frac{\rho * d * \left(\frac{dE}{dx} \right)_0 * F * S}{m}$$

Comparison of experimental and theoretical values of absorbed dose, Mrad



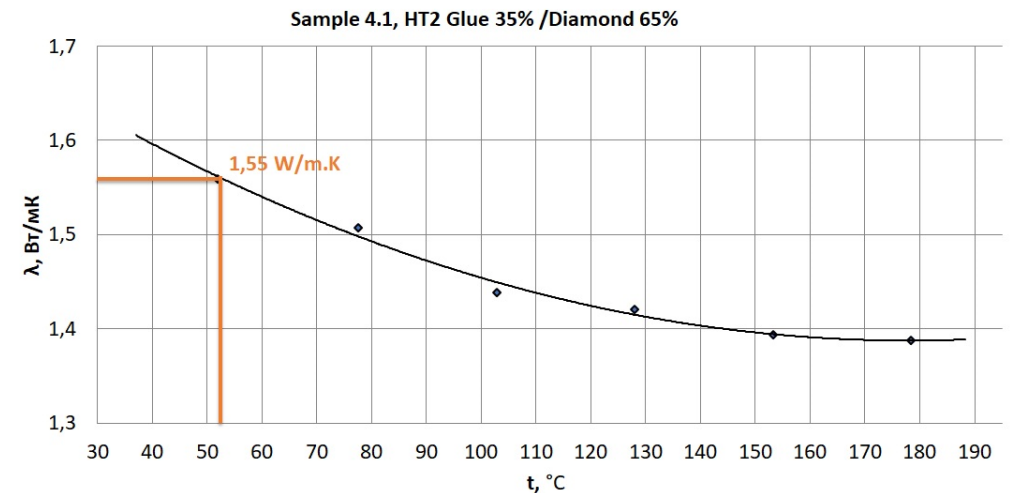
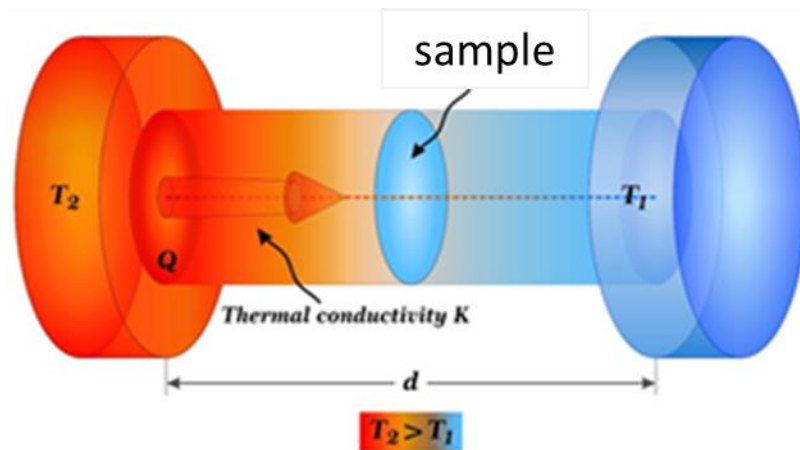
Thermal conductivity measurement

Sample sizes : \varnothing 15 mm, d = 5 mm.

With the help of what? Specialized equipment - IT- λ -400

Duration of measurements t \leq 2,5 hours

Where? D.I.Mendeleev Institute for Metrology (VNIIM) in SPb by V.Mekhiev.



Final result of these measurements the thermal conductivity

Thermal conductivity of the samples before and after irradiation

Measured samples:

No1. Glue HT2 23 %

Diam. powder - 77 %

Two fractions of diamond

D1 – 8.5 μm – 56%

D2 – 50 μm – 21%

No2. Glue HT2

Diam. powder - 65%

D2 – 8,5 μm -75%

No3. Glue ED -20

Diam. powder - 50%

D1 - 8.5 μm - 37%

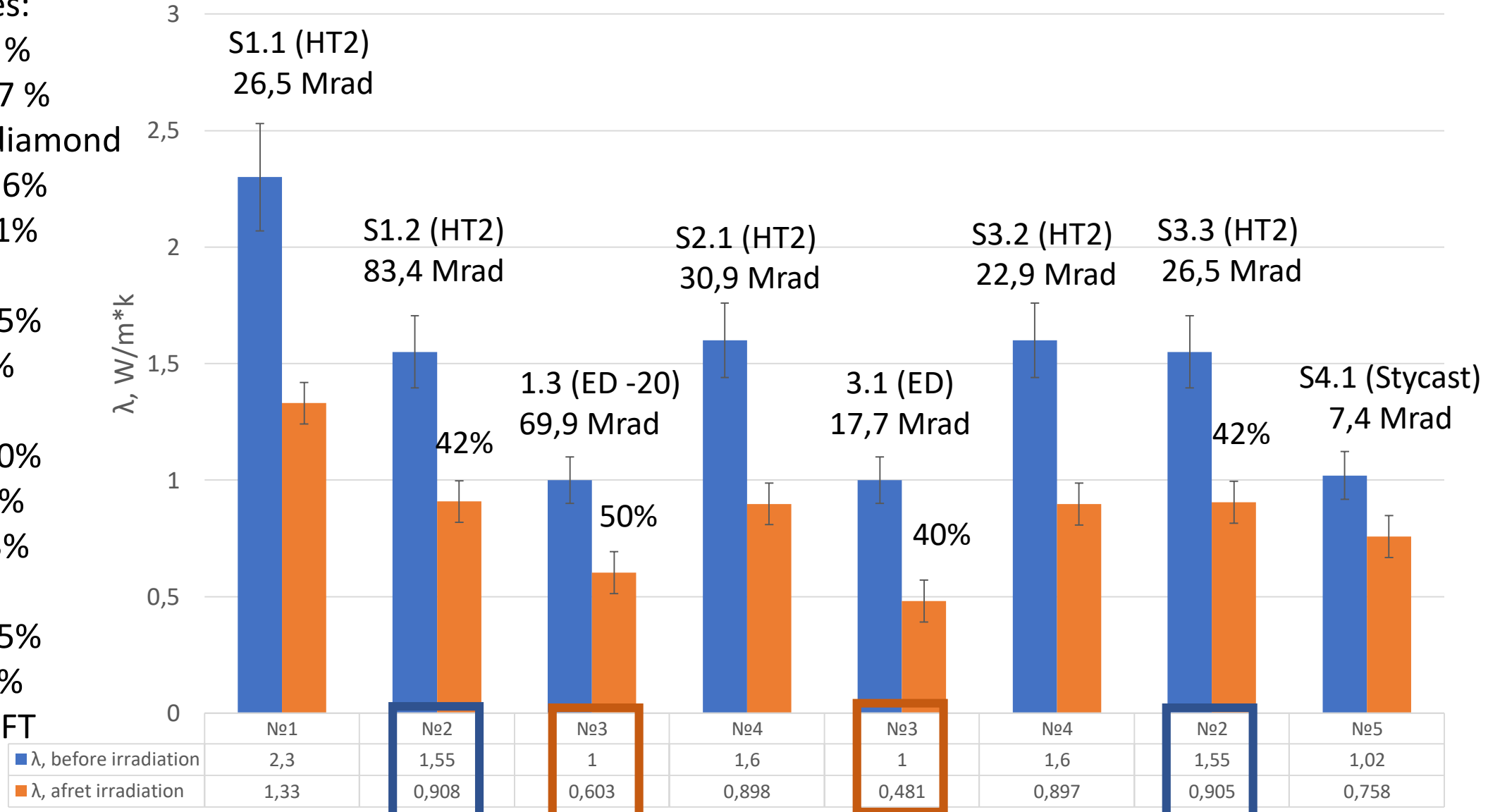
D2 – 50 μm – 13%

No4. Glue HT2

Diam. powder - 65%

D1 – 8.5 μm- 35%

No5. Stycast 2850FT



Conclusion

- ❖ *A rather simple method was established for studying the degradation of the thermal properties of composite dielectric glues (made of epoxy and diamond powder).*
- ❖ *The dose absorbed by the irradiated glue samples was determined by the activation analysis of the aluminum monitor foils placed close the samples and combined with theoretical estimations calculated using FLUKA and MCNPX simulations.*
- ❖ *The absorb dose accuracy of the method is estimated 25-30%*
- ❖ *The thermal conductivity (measured 10% accuracy) of the irradiated samples decreased by 40-50% within the range of doses from about 7 to over 80 Mrad.*
- ❖ *The main advantage of the method is the simplicity and ability to obtain data on different dose levels in one irradiation.*

Future work:

- *Include various dielectric fillers.*
- Increasing the number of irradiated samples to improve the reliability of the results.
- *Simplification of the setup design to minimize its impact on the accuracy of absorbed dose measurements.*
- *Include in the study the degradation of electromechanical properties of samples:*
 - *Dielectric strength*
 - *Mechanical strength*

*Thank you
for your
attention*

